

## 58V Asynchronous Buck Controller

### ❖ GENERAL DESCRIPTION

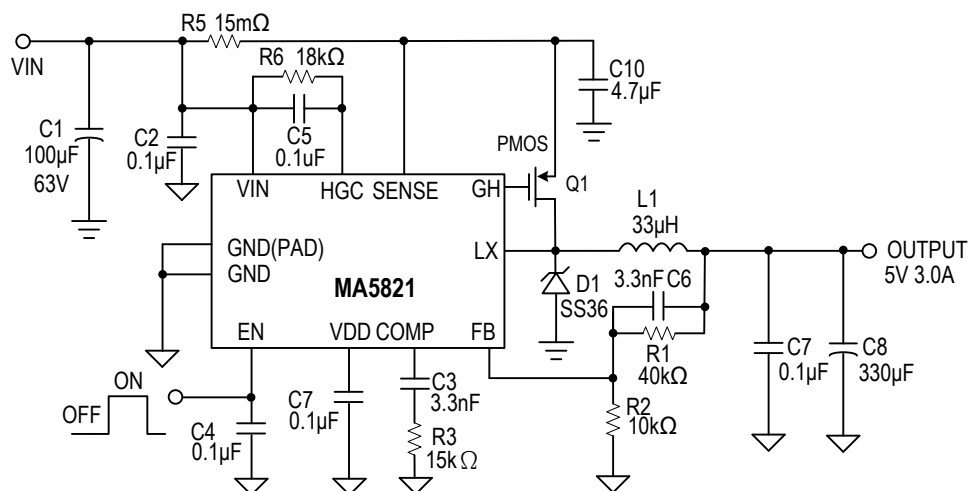
The MA5821 is an asynchronous buck controller. The device needs external high side power MOSFET and low side schottky diode, and provides 3A of continuous load current over a wide input voltage of 10V to 58V range. Current mode control provides fast transient response and cycle-bicycle current limit. An internal soft-start function prevents inrush current at turn-on.

This device is available in small MSOP-10L-EP package, and provides a very compact solution with minimal external components.

### ❖ FEATURES

- Wide 10V~ 58V Operating Input Range
- External High-Side P-channel MOSFET Switch
- Output Adjustable :  $V_{FB}(1.00V \pm 2\%)$
- Up to 93% Efficiency
- Internal Soft-Start / Thermal Shutdown Protection
- Fixed 240KHz Frequency
- Cycle-by-Cycle Over Current Protection
- Input Under/Over Voltage Lockout

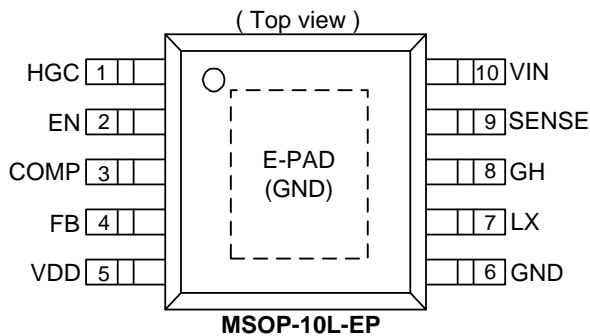
### ❖ APPLICATION CIRCUIT



$$V_{OUT} = V_{FB} \times (1 + R1/R2), V_{FB} = 1.0V, R2 \text{ suggest } 1K \sim 30K\Omega.$$

**❖ PIN ASSIGNMENT**

The package of MA5821 is MSOP10L-EP (Exposed pad); the pin assignment is given by:



Name	Description
<b>HGC</b>	Supply high-side gate driver. Decouple this pin to VIN pin with 0.1uf ceramic CAP (e.g. X5R) and 18kΩ
<b>EN</b>	Enable Control. ( internal pull high ).
<b>COMP</b>	Compensation Node. Connect a series RC network from COMP to GND.
<b>FB</b>	Feedback Input. FB senses the output voltage to regulate that voltage. Drive FB with a resistive voltage divider from the output voltage.
<b>VDD</b>	Internal Regulator Pin
<b>GND</b>	Ground.
<b>LX</b>	Switching node and Switching sense pin.
<b>GH</b>	Gate driver for external high-side PMOS.
<b>SENSE</b>	Power Input and Current Limit SENSE pin. Bypass SENSE (of High-side PMOS) to Ground with high capacitance 4.7uF ceramic MLCC (e.g. X5R) to eliminate noise. Ensure a very large SENSE area for high-side PMOS cooling.
<b>VIN</b>	Power Input. Bypass VIN to Ground with a suitably high capacitance E-CAP to eliminate noise, and bypass IC PIN10-VIN to pin6-GND with a 0.1uf ceramic MLCC (e.g. X5R.)
<b>E-PAD</b>	Exposed pad. Connect to GND.

**❖ ORDER/MARKING INFORMATION**

Order Information	Top Marking
<p><b>MA5821XXX</b> → Packing Blank: Tube A : Taping</p> <p>Package Type EM: MSOP10L-EP</p>	<p><b>MA5821</b> → Part number <b>XXXXX</b> → ID code:internal           → WW:01~52           → Year:18=2018</p>